

B660M-HDVP/D5 H610M-HDVP/D5

Version 1.0

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Chapter 1 Introduction

Thank you for purchasing ASRock B660M-HDVP/D5 R2.0 / H610M-HDVP/D5 R2.0 motherboard, a reliable motherboard produced under ASRock's consistently stringent quality control. It delivers excellent performance with robust design conforming to ASRock's commitment to quality and endurance.

In this documentation, Chapter 1 and 2 contains the introduction of the motherboard and step-by-step installation guides. Chapter 3 contains the operation guide of the software and utilities. Chapter 4 contains the configuration guide of the BIOS setup.



Because the motherboard specifications and the BIOS software might be updated, the content of this documentation will be subject to change without notice. In case any modifications of this documentation occur, the updated version will be available on ASRock's website without further notice. If you require technical support related to this motherboard, please visit our website for specific information about the model you are using. You may find the latest VGA cards and CPU support list on ASRock's website as well. ASRock website <http://www.asrock.com>.

1.1 Package Contents

- ASRock B660M-HDVP/D5 R2.0 / H610M-HDVP/D5 R2.0 Motherboard (Micro ATX Form Factor)
- ASRock B660M-HDVP/D5 R2.0 / H610M-HDVP/D5 R2.0 Quick Installation Guide
- ASRock B660M-HDVP/D5 R2.0 / H610M-HDVP/D5 R2.0 Support CD
- 2 x Serial ATA (SATA) Data Cables (Optional)
- 1 x Screw for M.2 Socket
- 1 x I/O Panel Shield

1.2 Specifications

- Platform**
- Micro ATX Form Factor
 - Solid Capacitor design

- CPU**
- Supports 14th, 13th & 12th Gen Intel® Core™ Processors (LGA1700)
 - 5 Power Phase design
 - Supports Intel® Hybrid Technology
 - Supports Intel® Turbo Boost Max 3.0 Technology

- Chipset**
- B660M-HDVP/D5 R2.0:**
- Intel® B660
- H610M-HDVP/D5 R2.0:**
- Intel® H610

- Memory**
- 2 x DDR5 DIMM Slots
 - Max. capacity of system memory: 64GB
 - Supports Intel® Extreme Memory Profile (XMP) 3.0
- B660M-HDVP/D5 R2.0:**
- Supports DDR5 non-ECC, un-buffered memory up to 6200+(OC)*
1DPC 1R Up to 6200+ MHz (OC), 4800 MHz Natively.
1DPC 2R Up to 5800+ MHz (OC), 4800 MHz Natively.
- * Please refer to Memory Support List on ASRock's website for more information. (<http://www.asrock.com/>)
- H610M-HDVP/D5 R2.0:**
- Supports DDR5 non-ECC, un-buffered memory up to 5600*
- * Actual support may vary by CPU
- * Supports DDR5 4800 (1DPC) natively.
- * Please refer to Memory Support List on ASRock's website for more information. (<http://www.asrock.com/>)

- Expansion Slot**
- CPU:
- 1 x PCIe 4.0 x16 (PCIe1), supports x16 mode*
- Chipset:
- 2 x PCIe 3.0 x1 Slots (PCIe2 and PCIe3)*
- ASMedia ASM1083:
- 1 x PCI Slot

* Supports NVMe SSD as boot disks

Graphics

- Intel® UHD Graphics Built-in Visuals and the VGA outputs can be supported only with processors which are GPU integrated.
- Intel® X^e Graphics Architecture (Gen 12)
- Four graphics output options: D-Sub, DVI-D, HDMI and DisplayPort 1.4

*Supports up to 3 displays simultaneously (for H610M-HDVP/D5 R2.0 only)

- Supports Quad Monitor (for B660M-HDVP/D5 R2.0 only)
- Supports HDMI 2.1 TMDS Compatible with max. resolution up to 4K x 2K (4096x2160) @ 60Hz
- Supports DVI-D with max. resolution up to 1920x1200 @ 60Hz
- Supports D-Sub with max. resolution up to 1920x1200 @ 60Hz
- Supports DisplayPort 1.4 with DSC (compressed) max. resolution up to 8K (7680x4320) @ 60Hz / 5K (5120x3200) @ 120Hz
- Supports HDCP 2.3 with HDMI 2.1 TMDS Compatible and DisplayPort 1.4 Ports

Audio

- 7.1 CH HD Audio (Realtek ALC897 Audio Codec)
- Supports Surge Protection

LAN

- PCIE x1 Gigabit LAN 10/100/1000 Mb/s
- Realtek RTL8111H
- Supports Wake-On-LAN
- Supports Lightning/ESD Protection
- Supports Energy Efficient Ethernet 802.3az
- Supports PXE

Rear Panel I/O

- 1 x PS/2 Keyboard Port
- 1 x PS/2 Mouse Port
- 1 x Serial Port: COM1
- 1 x D-Sub Port
- 1 x DVI-D Port
- 1 x HDMI Port
- 1 x DisplayPort 1.4
- 2 x USB 2.0 Ports (Supports ESD Protection)

- 1 x RJ-45 LAN Port with LED (ACT/LINK LED and SPEED LED)
- HD Audio Jacks: Line in / Front Speaker / Microphone

B660M-HDVP/D5 R2.0:

- 4 x USB 3.2 Gen1 Ports (Supports ESD Protection)

H610M-HDVP/D5 R2.0:

- 2 x USB 3.2 Gen1 Ports (Supports ESD Protection)

Storage

B660M-HDVP/D5 R2.0:

Chipset:

- 1 x Hyper M.2 Socket (M2_1, Key M), supports type 2242/2260/2280 PCIe Gen4x4 (64 Gb/s) mode*
- 4 x SATA3 6.0 Gb/s Connectors

* Supports Intel® Optane™ Technology

* Supports Intel® Volume Management Device (VMD)

* Supports NVMe SSD as boot disks

* Supports ASRock U.2 Kit

H610M-HDVP/D5 R2.0:

Chipset:

- 1 x Ultra M.2 Socket (M2_1, Key M), supports type 2242/2260/2280 SATA3 6.0 Gb/s & PCIe Gen3x4 (32 Gb/s) modes*
- 4 x SATA3 6.0 Gb/s Connectors**

* Supports NVMe SSD as boot disks

* Supports ASRock U.2 Kit

** If M2_1 is occupied by a SATA-type M.2 device, SATA3_0 will be disabled.

RAID (for

B660M-HDVP/D5 R2.0 only)

- Supports RAID 0, RAID 1, RAID 5 and RAID 10 for SATA storage devices

Connector

- 1 x Print Port Header
- 1 x COM Port Header
- 1 x SPI TPM Header
- 1 x Chassis Intrusion and Speaker Header

- 1 x CPU Fan Connector (4-pin)
- * The CPU Fan Connector supports the CPU fan of maximum 1A (12W) fan power.
- 1 x Chassis Fan Connector (4-pin)
- * The Chassis Fan supports the Chassis fan of maximum 1A (12W) fan power.
- 1 x Chassis/Water Pump Fan Connector (4-pin) (Smart Fan Speed Control)
- * The Chassis/Water Pump Fan supports the water cooler fan of maximum 2A (24W) fan power.
- * CHA_FAN1/WP can auto detect if 3-pin or 4-pin fan is in use.
- 1 x 24 pin ATX Power Connector
- 1 x 8 pin 12V Power Connector
- 1 x Front Panel Audio Connector
- 2 x USB 2.0 Headers (Support 4 USB 2.0 ports) (Supports ESD Protection)
- 1 x USB 3.2 Gen1 Header (Supports 2 USB 3.2 Gen1 ports) (Supports ESD Protection)

**BIOS
Feature**

- AMI UEFI Legal BIOS with multilingual GUI support
- ACPI 6.0 Compliant wake up events
- SMBIOS 2.7 Support
- CPU Core/Cache, CPU GT, VDD_CPU, VDD_IMC, VCCIN AUX, +1.05V PROC, +0.82V PCH , +1.05V PCH Voltage Multi-adjustment

**Hardware
Monitor**

- Fan Tachometer: CPU, Chassis, Chassis/Water Pump Fans
- Quiet Fan (Auto adjust chassis fan speed by CPU temperature): CPU, Chassis, Chassis/Water Pump Fans
- Fan Multi-Speed Control: CPU, Chassis, Chassis/Water Pump Fans
- CASE OPEN detection
- Voltage monitoring: CPU Vcore, +1.05V_PCH, VDD_CPU, VCCIN AUX, +1.05V PROC, +0.82V PCH, +12V, +5V, +3.3V, VCCSA

OS

- Microsoft® Windows® 10 64-bit / 11 64-bit

Certifications

- FCC, CE
- ErP/EuP Ready (ErP/EuP ready power supply is required)

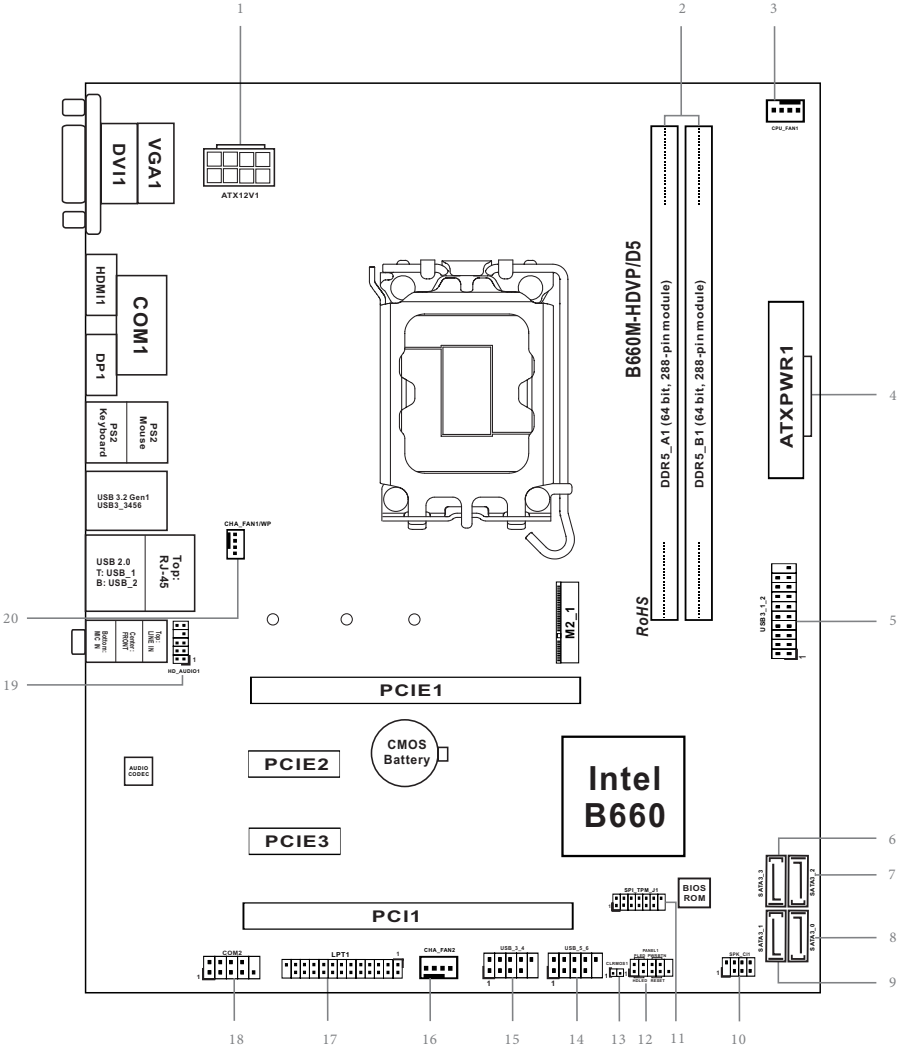
* For detailed product information, please visit our website: <http://www.asrock.com>



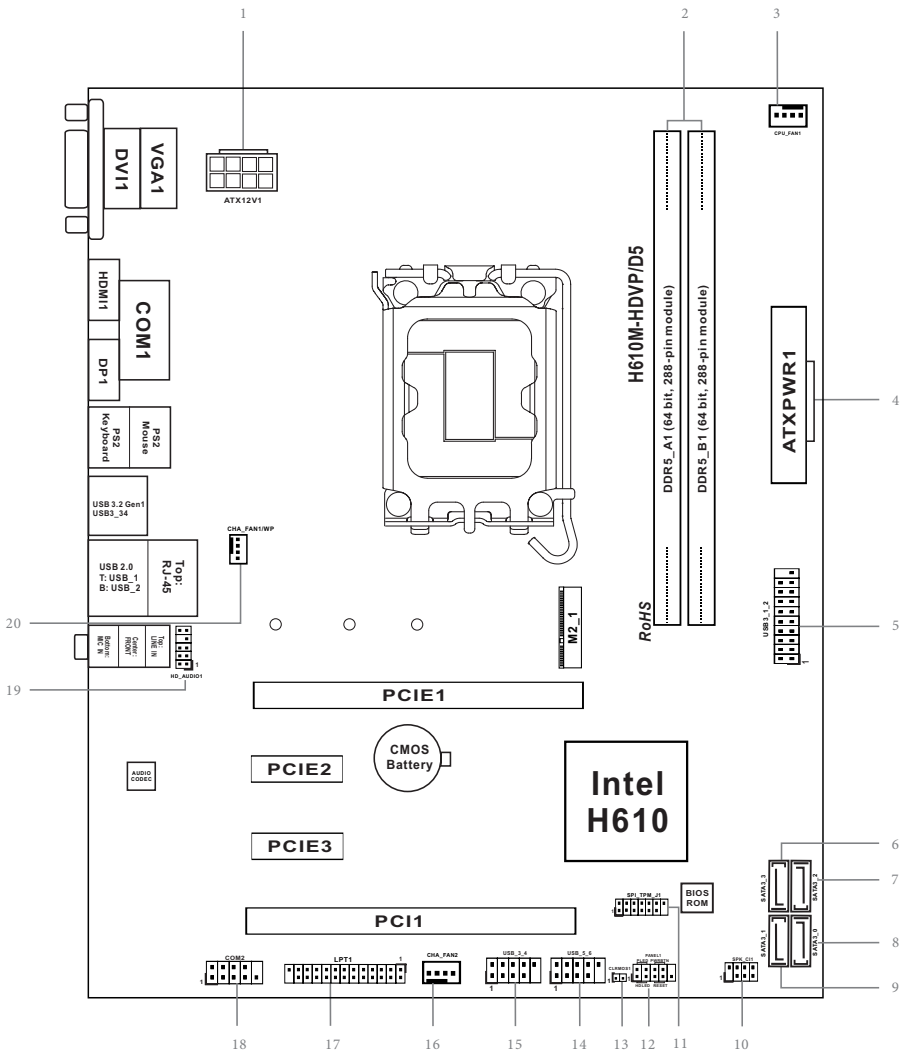
Please realize that there is a certain risk involved with overclocking, including adjusting the setting in the BIOS, applying Untied Overclocking Technology, or using third-party overclocking tools. Overclocking may affect your system's stability, or even cause damage to the components and devices of your system. It should be done at your own risk and expense. We are not responsible for possible damage caused by overclocking.

1.3 Motherboard Layout

B660M-HDVP/D5 R2.0



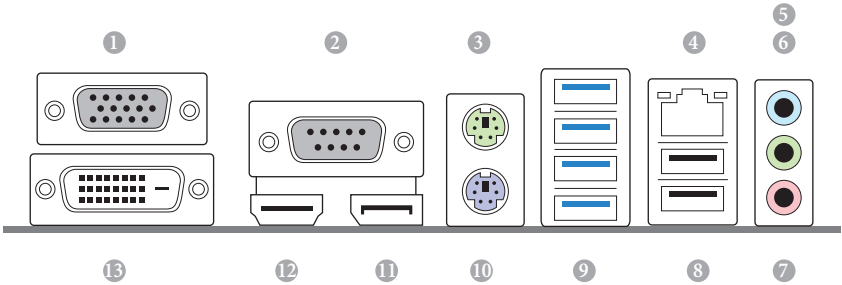
H610M-HDVP/D5 R2.0



No.	Description
1	ATX 12V Power Connector (ATX12V1)
2	2 x 288-pin DDR5 DIMM Slots (DDR5_A1, DDR5_B1)
3	CPU Fan Connector (CPU_FAN1)
4	ATX Power Connector (ATXPWR1)
5	USB 3.2 Gen1 Header (USB3_1_2)
6	SATA3 Connector (SATA3_3)
7	SATA3 Connector (SATA3_2)
8	SATA3 Connector (SATA3_0)
9	SATA3 Connector (SATA3_1)
10	Chassis Intrusion and Speaker Header (SPK_C11)
11	SPI TPM Header (SPI_TPM_I1)
12	System Panel Header (PANEL1)
13	Clear CMOS Jumper (CLRMOS1)
14	USB 2.0 Header (USB_5_6)
15	USB 2.0 Header (USB_3_4)
16	Chassis Fan Connector (CHA_FAN2)
17	Print Port Header (LPT1)
18	COM Port Header (COM2)
19	Front Panel Audio Header (HD_AUDIO1)
20	Chassis/Water Pump Fan Connector (CHA_FAN1/WP)

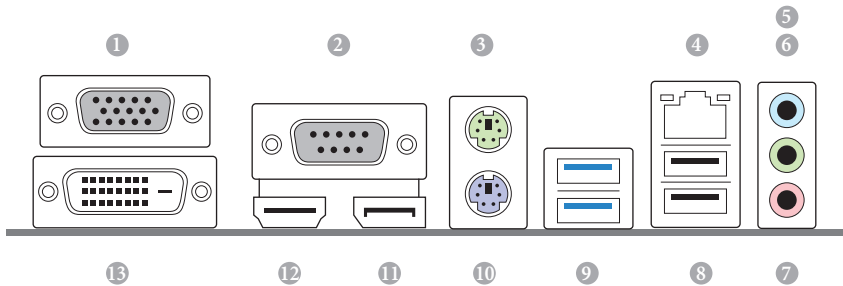
1.4 I/O Panel

B660M-HDVP/D5 R2.0



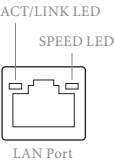
No.	Description	No.	Description
1	D-Sub Port	8	USB 2.0 Ports (USB_12)
2	Serial Port: COM1	9	USB 3.2 Gen1 Ports (USB3_3456)
3	PS/2 Mouse Port	10	PS/2 Keyboard Port
4	LAN RJ-45 Port*	11	DisplayPort 1.4
5	Line In (Light Blue)**	12	HDMI Port
6	Front Speaker (Lime)**	13	DVI-D Port
7	Microphone (Pink)**		

H610M-HDVP/D5 R2.0



No.	Description	No.	Description
1	D-Sub Port	8	USB 2.0 Ports (USB_12)
2	Serial Port: COM1	9	USB 3.2 Gen1 Ports (USB3_34)
3	PS/2 Mouse Port	10	PS/2 Keyboard Port
4	LAN RJ-45 Port*	11	DisplayPort 1.4
5	Line In (Light Blue)**	12	HDMI Port
6	Front Speaker (Lime)**	13	DVI-D Port
7	Microphone (Pink)**		

* There are two LEDs on the LAN port. Please refer to the table below for the LAN port LED indications.



Activity / Link LED		Speed LED	
Status	Description	Status	Description
Off	No Link	Off	10Mbps connection
Blinking	Data Activity	Orange	100Mbps connection
On	Link	Green	1Gbps connection

** Function of the Audio Ports in 7.1-channel Configuration:

Port	Function
Light Blue (Rear panel)	Rear Speaker Out
Lime (Rear panel)	Front Speaker Out
Pink (Rear panel)	Central /Subwoofer Speaker Out
Lime (Front panel)	Side Speaker Out

Chapter 2 Installation

This is a Micro ATX form factor motherboard. Before you install the motherboard, study the configuration of your chassis to ensure that the motherboard fits into it.

Pre-installation Precautions

Take note of the following precautions before you install motherboard components or change any motherboard settings.

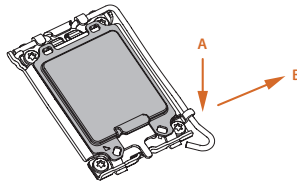
- Make sure to unplug the power cord before installing or removing the motherboard components. Failure to do so may cause physical injuries and damages to motherboard components.
- In order to avoid damage from static electricity to the motherboard's components, NEVER place your motherboard directly on a carpet. Also remember to use a grounded wrist strap or touch a safety grounded object before you handle the components.
- Hold components by the edges and do not touch the ICs.
- Whenever you uninstall any components, place them on a grounded anti-static pad or in the bag that comes with the components.
- When placing screws to secure the motherboard to the chassis, please do not over-tighten the screws! Doing so may damage the motherboard.

2.1 Installing the CPU

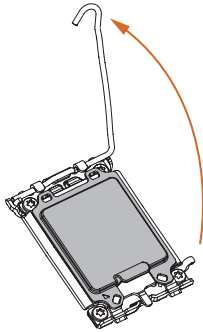


1. Before you insert the 1700-Pin CPU into the socket, please check if the **PnP cap** is on the socket, if the CPU surface is unclean, or if there are any **bent pins** in the socket. Do not force to insert the CPU into the socket if above situation is found. Otherwise, the CPU will be seriously damaged.
2. Unplug all power cables before installing the CPU.

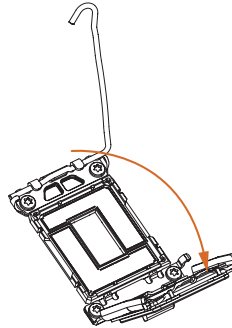
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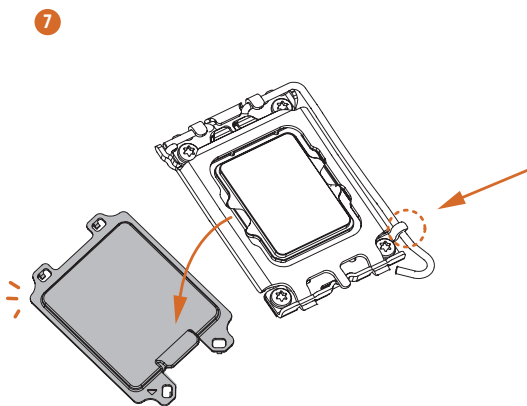
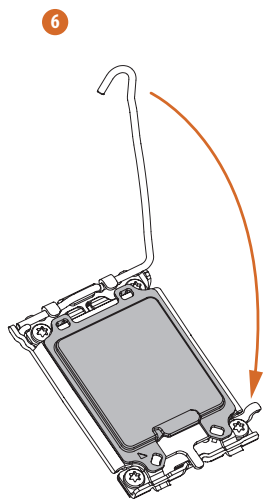
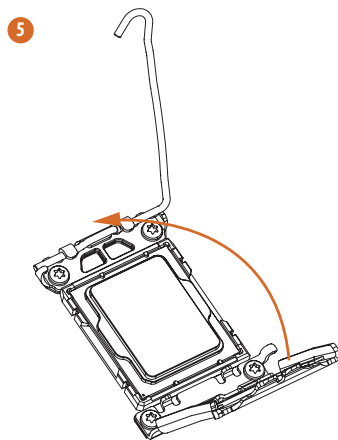
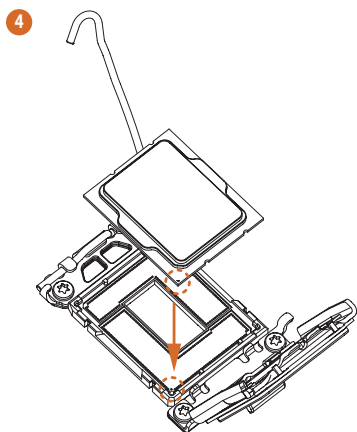


2



3

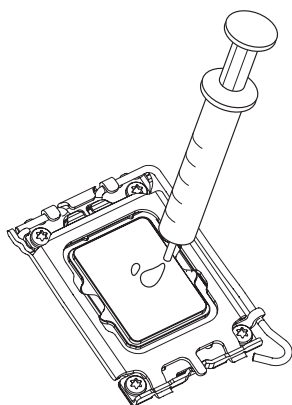




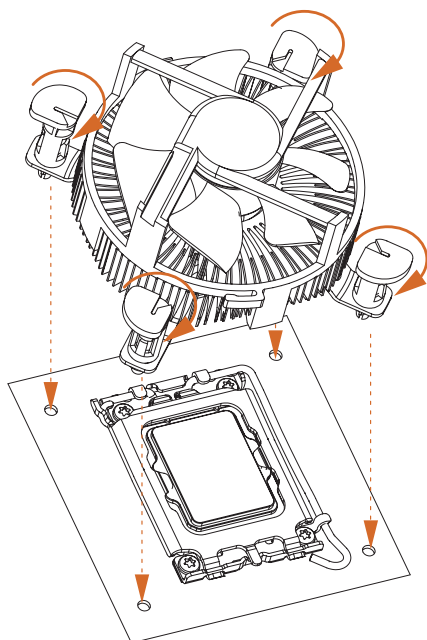


Please save and replace the cover if the processor is removed. The cover must be placed if you wish to return the motherboard for after service.

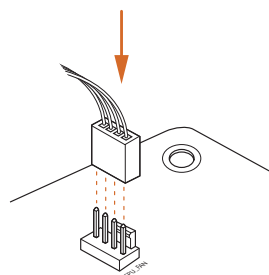
2.2 Installing the CPU Fan and Heatsink



1



2



2.3 Installing Memory Modules (DIMM)

This motherboard provides two 288-pin DDR5 (Double Data Rate 5) DIMM slots, and supports Dual Channel Memory Technology.

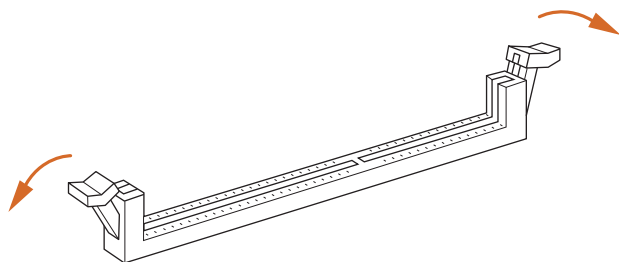


1. For dual channel configuration, you always need to install identical (the same brand, speed, size and chip-type) DDR5 DIMM pairs.
2. It is unable to activate Dual Channel Memory Technology with only one memory module installed.
3. It is not allowed to install a DDR, DDR2, DDR3 or DDR4 memory module into a DDR5 slot; otherwise, this motherboard and DIMM may be damaged.

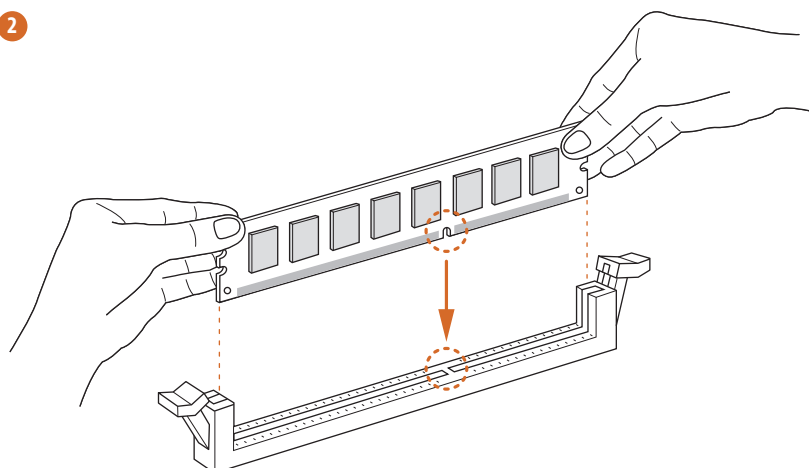


The DIMM only fits in one correct orientation. It will cause permanent damage to the motherboard and the DIMM if you force the DIMM into the slot at incorrect orientation.

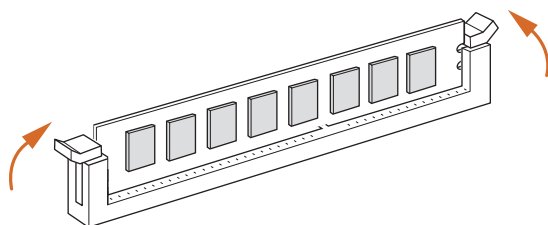
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2



3



2.4 Expansion Slots (PCI and PCIe Slots)

There are 1 PCI slot and 3 PCIe slots on the motherboard.



Before installing an expansion card, please make sure that the power supply is switched off or the power cord is unplugged. Please read the documentation of the expansion card and make necessary hardware settings for the card before you start the installation.

PCI slots:

The PCI1 slot is used to install expansion card that have 32-bit PCI interface.

PCIe slots:

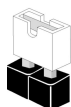
PCIE1 (PCIe 4.0 x16 slot) is used for PCIe x16 lane width graphics cards.

PCIE2 (PCIe 3.0 x1 slot) is used for PCIe x1 lane width cards.

PCIE3 (PCIe 3.0 x1 slot) is used for PCIe x1 lane width cards.

2.5 Jumpers Setup

The illustration shows how jumpers are setup. When the jumper cap is placed on the pins, the jumper is “Short”. If no jumper cap is placed on the pins, the jumper is “Open”.



Short



Open

Clear CMOS Jumper
(CLRMOS1)
(see p.7, 8, No. 13)



2-pin Jumper

CLRMOS1 allows you to clear the data in CMOS. To clear and reset the system parameters to default setup, please turn off the computer and unplug the power cord from the power supply. After waiting for 15 seconds, use a jumper cap to short the pins on CLRMOS1 for 5 seconds. However, please do not clear the CMOS right after you update the BIOS. If you need to clear the CMOS when you just finish updating the BIOS, you must boot up the system first, and then shut it down before you do the clear-CMOS action. Please be noted that the password, date, time, and user default profile will be cleared only if the CMOS battery is removed. Please remember to remove the jumper cap after clearing the CMOS.



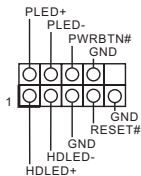
If you clear the CMOS, the case open may be detected. Please adjust the BIOS option “Clear Status” to clear the record of previous chassis intrusion status.

2.6 Onboard Headers and Connectors



Onboard headers and connectors are NOT jumpers. Do NOT place jumper caps over these headers and connectors. Placing jumper caps over the headers and connectors will cause permanent damage to the motherboard.

System Panel Header
(9-pin PANEL1)
(see p.7, 8, No. 12)



Connect the power switch, reset switch and system status indicator on the chassis to this header according to the pin assignments below. Note the positive and negative pins before connecting the cables.



PWRBTN (Power Switch):

Connect to the power switch on the chassis front panel. You may configure the way to turn off your system using the power switch.

RESET (Reset Switch):

Connect to the reset switch on the chassis front panel. Press the reset switch to restart the computer if the computer freezes and fails to perform a normal restart.

PLED (System Power LED):

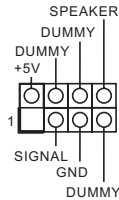
Connect to the power status indicator on the chassis front panel. The LED is on when the system is operating. The LED keeps blinking when the system is in S1/S3 sleep state. The LED is off when the system is in S4 sleep state or powered off (S5).

HDLED (Hard Drive Activity LED):

Connect to the hard drive activity LED on the chassis front panel. The LED is on when the hard drive is reading or writing data.

The front panel design may differ by chassis. A front panel module mainly consists of power switch, reset switch, power LED, hard drive activity LED, speaker and etc. When connecting your chassis front panel module to this header, make sure the wire assignments and the pin assignments are matched correctly.

Chassis Intrusion and
Speaker Header
(7-pin SPK_C11)
(see p.7, 8, No. 10)



Please connect the
chassis intrusion and the
chassis speaker to this header.

Serial ATA3 Connectors

Vertical:

(SATA3_0:

see p.7, 8, No. 8)

(SATA3_1:

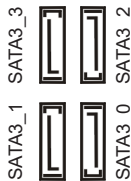
see p.7, 8, No. 9)

(SATA3_2:

see p.7, 8, No. 7)

(SATA3_3:

see p.7, 8, No. 6)



These four SATA3 connectors
support SATA data cables for
internal storage devices with
up to 6.0 Gb/s data transfer
rate.

*If M2_1 is occupied by
a SATA-type M.2 device,
SATA3_0 will be disabled
(for H610M-HDVP/D5 R2.0
only).

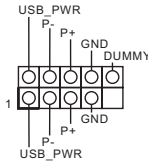
USB 2.0 Headers

(9-pin USB_3_4)

(see p.7, 8, No. 15)

(9-pin USB_5_6)

(see p.7, 8, No. 14)

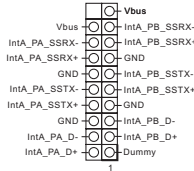


There are two USB 2.0 headers
on this motherboard. Each
USB 2.0 header can support
two ports.

USB 3.2 Gen1 Header

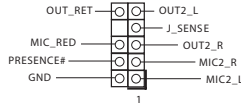
(19-pin USB3_1_2)

(see p.7, 8, No. 5)



There is one USB 3.2 Gen1
header on this motherboard.
This USB 3.2 Gen1 header can
support two ports.

Front Panel Audio Header
(9-pin HD_AUDIO1)
(see p.7, 8, No. 19)

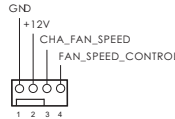


This header is for connecting audio devices to the front audio panel.



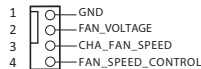
1. High Definition Audio supports Jack Sensing, but the panel wire on the chassis must support HDA to function correctly. Please follow the instructions in our manual and chassis manual to install your system.
2. If you use an AC'97 audio panel, please install it to the front panel audio header by the steps below:
 - A. Connect Mic_IN (MIC) to MIC2_L.
 - B. Connect Audio_R (RIN) to OUT2_R and Audio_L (LIN) to OUT2_L.
 - C. Connect Ground (GND) to Ground (GND).
 - D. MIC_RET and OUT_RET are for the HD audio panel only. You don't need to connect them for the AC'97 audio panel.
 - E. To activate the front mic, go to the "FrontMic" Tab in the Realtek Control panel and adjust "Recording Volume".

Chassis Fan Connector
(4-pin CHA_FAN2)
(see p.7, 8, No. 16)



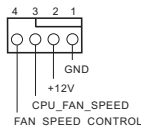
Please connect fan cable to the fan connector and match the black wire to the ground pin.

Chassis/Water Pump Fan Connector
(4-pin CHA_FAN1/WP)
(see p.7, 8, No. 20)



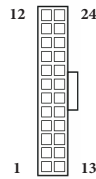
This motherboard provides a 4-Pin water cooling chassis fan connector. If you plan to connect a 3-Pin chassis water cooler fan, please connect it to Pin 1-3.

CPU Fan Connector
(4-pin CPU_FAN1)
(see p.7, 8, No. 3)



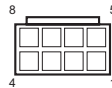
This motherboard provides a 4-Pin CPU fan (Quiet Fan) connector. If you plan to connect a 3-Pin CPU fan, please connect it to Pin 1-3.

ATX Power Connector
(24-pin ATXPWR1)
(see p.7, 8, No. 4)



This motherboard provides a 24-pin ATX power connector. To use a 20-pin ATX power supply, please plug it along Pin 1 and Pin 13.

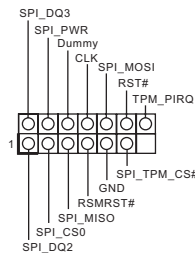
ATX 12V Power Connector
(8-pin ATX12V1)
(see p.7, 8, No. 1)



This motherboard provides a 8-pin ATX 12V power connector. To use a 4-pin ATX power supply, please plug it along Pin 1 and Pin 5.

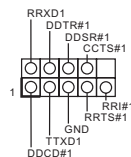
***Warning: Please make sure that the power cable connected is for the CPU and not the graphics card. Do not plug the PCIe power cable to this connector.**

SPI TPM Header
(13-pin SPI_TPM_J1)
(see p.7, 8, No. 11)



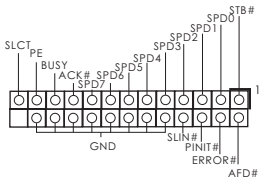
This connector supports SPI Trusted Platform Module (TPM) system, which can securely store keys, digital certificates, passwords, and data. A TPM system also helps enhance network security, protects digital identities, and ensures platform integrity.

Serial Port Header
(9-pin COM2)
(see p.7, 8, No. 18)



This COM header supports serial port module.

Print Port Header
(25-pin LPT1)
(see p.7, 8, No. 17)



This is an interface for
print port cable that allows
convenient connection of
printer devices.

2.7 M.2_SSD (NGFF) Module Installation Guide (M2_1)

The M.2, also known as the Next Generation Form Factor (NGFF), is a small size and versatile card edge connector that aims to replace mPCIe and mSATA.

B660M-HDVP/D5 R2.0:

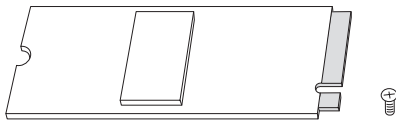
The Hyper M.2 Socket (M2_1, Key M) supports type 2242/2260/2280 PCIe Gen4x4 (64 Gb/s) mode.

H610M-HDVP/D5 R2.0:

The Ultra M.2 Socket (M2_1, Key M) supports type 2242/2260/2280 SATA3 6.0 Gb/s & PCIe Gen3x4 (32 Gb/s) modes.*

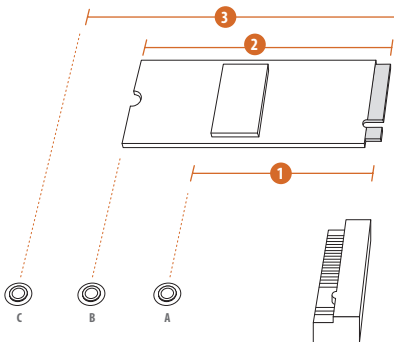
* If M2_1 is occupied by a SATA-type M.2 device, SATA3_0 will be disabled.

Installing the M.2_SSD (NGFF) Module



Step 1

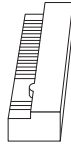
Prepare a M.2_SSD (NGFF) module and the screw.



Step 2

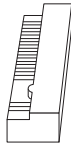
Depending on the PCB type and length of your M.2_SSD (NGFF) module, find the corresponding nut location to be used.

No.	1	2	3
Nut Location	A	B	C
PCB Length	4.2cm	6cm	8cm
Module Type	Type2242	Type2260	Type 2280



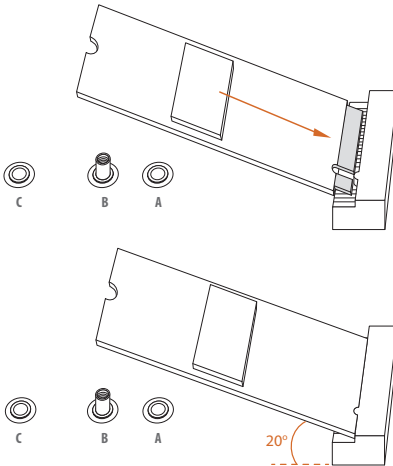
Step 3

Move the standoff based on the module type and length. The standoff is placed at the nut location C by default. Skip Step 3 and 4 and go straight to Step 5 if you are going to use the default nut. Otherwise, release the standoff by hand.



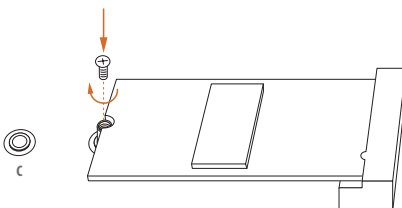
Step 4

Peel off the yellow protective film on the nut to be used. Hand tighten the standoff into the desired nut location on the motherboard.



Step 5

Align and gently insert the M.2 (NGFF) SSD module into the M.2 slot. Please be aware that the M.2 (NGFF) SSD module only fits in one orientation.



Step 6

Tighten the screw with a screwdriver to secure the module into place. Please do not overtighten the screw as this might damage the module.

M.2_SSD (NGFF) Module Support List (for B660M-HDVP/D5 R2.0)

Vendor	Interface	Length	P/N
ADATA	PCIe3 x4	2280	ASX7000NP-128GT-C
ADATA	PCIe3 x4	2280	ASX8000NP-256GM-C
ADATA	PCIe3 x4	2280	ASX7000NP-256GT-C
ADATA	PCIe3 x4	2280	ASX7000NP-512GT-C
ADATA	PCIe3 x4	2280	ASX8000NP-512GM-C
Corsair	PCIe3 x4	2280	CSSD-F240GBMP500
Intel	PCIe3 x4	2280	SSDPEKKF256G7
Intel	PCIe3 x4	2280	SSDPEKKF512G7
Kingston	PCIe2 x4	2280	SH2280S3/480G
OCZ	PCIe3 x4	2280	RVD400 -M2280-512G (NVME)
Plextor	PCIe3 x4	2280	PX-128M8PeG
Plextor	PCIe3 x4	2280	PX-1TM8PeG
Plextor	PCIe3 x4	2280	PX-256M8PeG
Plextor	PCIe3 x4	2280	PX-512M8PeG
Plextor	PCIe	2280	PX-G256M6e
Plextor	PCIe	2280	PX-G512M6e
Samsung	PCIe3 x4	2280	SM961 MZVPW128HEGM (NVM)
Samsung	PCIe3 x4	2280	PM961 MZVLW128HEGR (NVME)
Samsung	PCIe3 x4	2280	960 EVO (MZ-V6E250) (NVME)
Samsung	PCIe3 x4	2280	960 EVO (MZ-V6E250BW) (NVME)
Samsung	PCIe3 x4	2280	SM951 (NVME)
Samsung	PCIe3 x4	2280	SM951 (MZHPV256HDGL)
Samsung	PCIe3 x4	2280	SM951 (MZHPV512HDGL)
Samsung	PCIe3 x4	2280	SM951 (NVME)
Samsung	PCIe x4	2280	XP941-512G (MZHPU512HCGL)
SanDisk	PCIe	2260	SD6PP4M-128G
SanDisk	PCIe	2260	SD6PP4M-256G
TEAM	PCIe3 x4	2280	TM8FP2240G0C101
TEAM	PCIe3 x4	2280	TM8FP2480GC110
WD	PCIe3 x4	2280	WDS256G1X0C-00ENX0 (NVME)
WD	PCIe3 x4	2280	WDS512G1X0C-00ENX0 (NVME)

For the latest updates of M.2_SSD (NFGG) module support list, please visit our website for details: <http://www.asrock.com>

M.2_SSD (NGFF) Module Support List (for H610M-HDVP/D5 R2.0)

Vendor	Interface	P/N
ADATA	SATA3	AXNS330E-32GM-B
ADATA	SATA3	AXNS381E-128GM-B
ADATA	SATA3	AXNS381E-256GM-B
ADATA	SATA3	ASU800NS38-256GT-C
ADATA	SATA3	ASU800NS38-512GT-C
ADATA	PCIe3 x4	ASX7000NP-128GT-C
ADATA	PCIe3 x4	ASX8000NP-256GM-C
ADATA	PCIe3 x4	ASX7000NP-256GT-C
ADATA	PCIe3 x4	ASX8000NP-512GM-C
ADATA	PCIe3 x4	ASX7000NP-512GT-C
Apacer	PCIe3 x4	AP240GZ280
Corsair	PCIe3 x4	CSSD-F240GBMP500
Crucial	SATA3	CT120M500SSD4
Crucial	SATA3	CT240M500SSD4
Intel	SATA3	Intel SSDSCKGW080A401/80G
Intel	PCIe3 x4	SSDPEKKF256G7
Intel	PCIe3 x4	SSDPEKKF512G7
Kingston	SATA3	SM2280S3
Kingston	PCIe3 x4	SKC1000/480G
Kingston	PCIe2 x4	SH2280S3/480G
OCZ	PCIe3 x4	RVD400 -M2280-512G (NVME)
PATRIOT	PCIe3 x4	PH240GPM280SSDR NVME
Plextor	PCIe3 x4	PX-128M8PeG
Plextor	PCIe3 x4	PX-1TM8PeG
Plextor	PCIe3 x4	PX-256M8PeG
Plextor	PCIe3 x4	PX-512M8PeG
Plextor	PCIe	PX-G256M6e
Plextor	PCIe	PX-G512M6e
Samsung	PCIe3 x4	SM961 MZVPW128HEGM (NVM)
Samsung	PCIe3 x4	PM961 MZVLW128HEGR (NVME)
Samsung	PCIe3 x4	960 EVO (MZ-V6E250) (NVME)
Samsung	PCIe3 x4	960 EVO (MZ-V6E250BW) (NVME)
Samsung	PCIe3 x4	SM951 (NVME)
Samsung	PCIe3 x4	SM951 (MZHPV256HDGL)
Samsung	PCIe3 x4	SM951 (MZHPV512HDGL)
Samsung	PCIe3 x4	SM951 (NVME)
Samsung	PCIe x4	XP941-512G (MZHPU512HCGL)
SanDisk	PCIe	SD6PP4M-128G
SanDisk	PCIe	SD6PP4M-256G
Team	SATA3	TM4PS4128GMC105
Team	SATA3	TM4PS4256GMC105
Team	SATA3	TM8PS4128GMC105
Team	SATA3	TM8PS4256GMC105

TEAM	PCIe3 x4	TM8FP2240G0C101
TEAM	PCIe3 x4	TM8FP2480GC110
Transcend	SATA3	TS256GMTS400
Transcend	SATA3	TS512GMTS600
Transcend	SATA3	TS512GMTS800
V-Color	SATA3	VLM100-120G-2280B-RD
V-Color	SATA3	VLM100-240G-2280RGB
V-Color	SATA3	VSM100-240G-2280
V-Color	SATA3	VLM100-240G-2280B-RD
WD	SATA3	WDS100T1B0B-00AS40
WD	SATA3	WDS240G1G0B-00RC30
WD	PCIe3 x4	WDS256G1X0C-00ENX0 (NVME)
WD	PCIe3 x4	WDS512G1X0C-00ENX0 (NVME)

For the latest updates of M.2_SSD (NFGG) module support list, please visit our website for details: <http://www.asrock.com>

Chapter 3 Software and Utilities Operation

3.1 Installing Drivers

The Support CD that comes with the motherboard contains necessary drivers and useful utilities that enhance the motherboard's features.

Running The Support CD

To begin using the support CD, insert the CD into your CD-ROM drive. The CD automatically displays the Main Menu if "AUTORUN" is enabled in your computer. If the Main Menu does not appear automatically, locate and double click on the file "ASRSETUP.EXE" in the Support CD to display the menu.

Drivers Menu

The drivers compatible to your system will be auto-detected and listed on the support CD driver page. Please click **Install All** or follow the order from top to bottom to install those required drivers. Therefore, the drivers you install can work properly.

Utilities Menu

The Utilities Menu shows the application software that the motherboard supports. Click on a specific item then follow the installation wizard to install it.

3.2 ASRock Motherboard Utility (A-Tuning)

ASRock Motherboard Utility (A-Tuning) is ASRock's multi purpose software suite with a new interface, more new features and improved utilities.

3.2.1 Installing ASRock Motherboard Utility (A-Tuning)

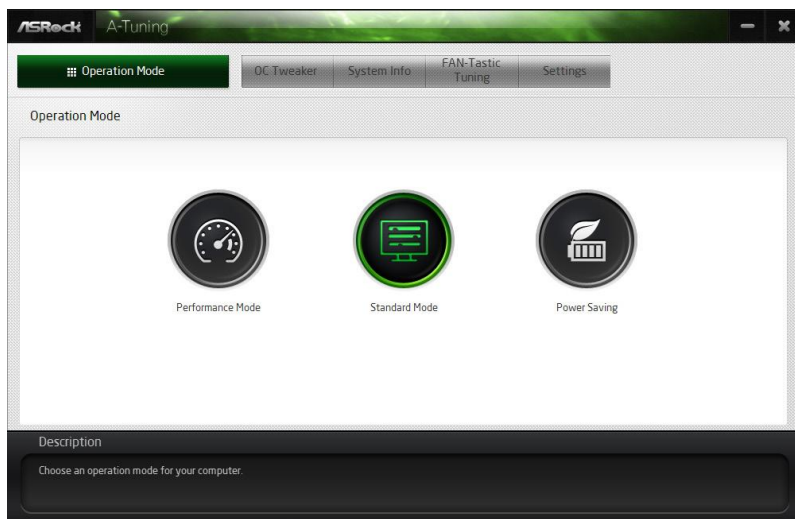
ASRock Motherboard Utility (A-Tuning) can be downloaded from ASRock Live Update & APP Shop. After the installation, you will find the icon "ASRock Motherboard Utility (A-Tuning)" on your desktop. Double-click the "ASRock Motherboard Utility (A-Tuning)"  icon, ASRock Motherboard Utility (A-Tuning) main menu will pop up.

3.2.2 Using ASRock Motherboard Utility (A-Tuning)

There are five sections in ASRock Motherboard Utility (A-Tuning) main menu: Operation Mode, OC Tweaker, System Info, FAN-Tastic Tuning and Settings.

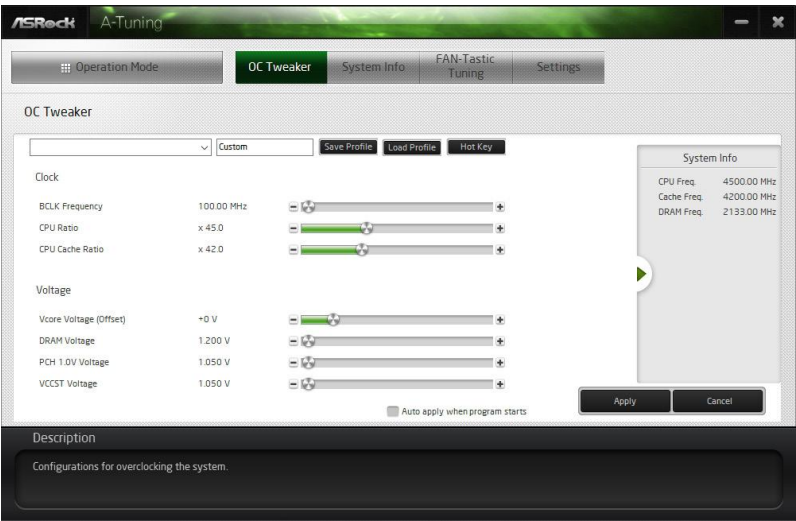
Operation Mode

Choose an operation mode for your computer.



OC Tweaker

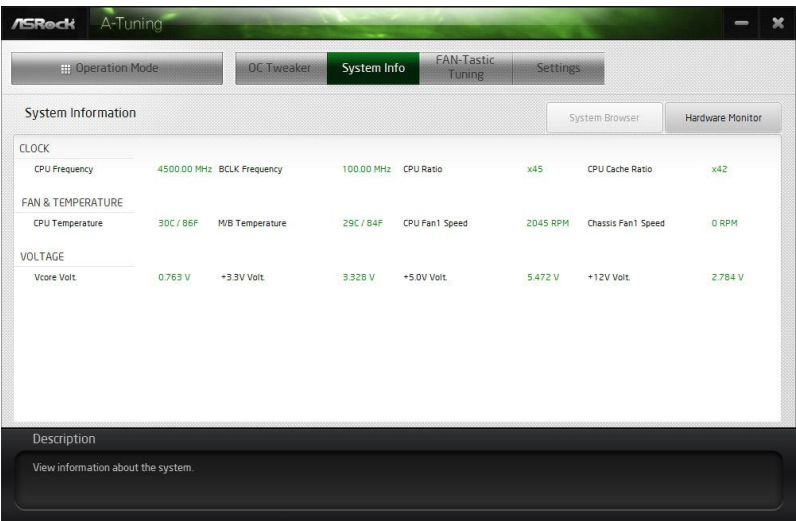
Configurations for overclocking the system.



System Info

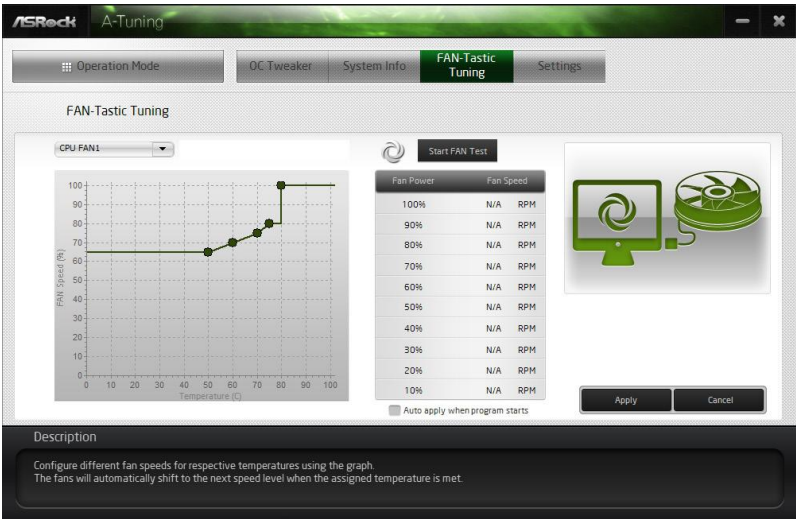
View information about the system.

*The System Browser tab may not appear for certain models.



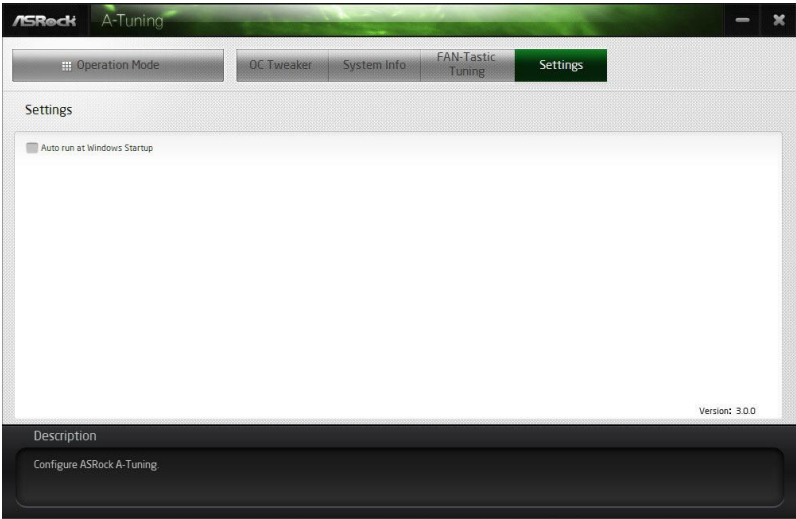
FAN-Tastic Tuning

Configure up to five different fan speeds using the graph. The fans will automatically shift to the next speed level when the assigned temperature is met.



Settings

Configure ASRock ASRock Motherboard Utility (A-Tuning). Click to select "Auto run at Windows Startup" if you want ASRock Motherboard Utility (A-Tuning) to be launched when you start up the Windows operating system.



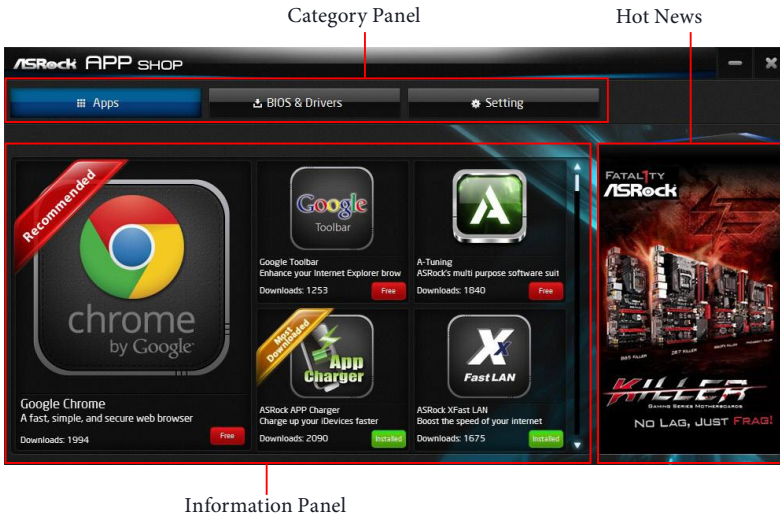
3.3 ASRock Live Update & APP Shop

The ASRock Live Update & APP Shop is an online store for purchasing and downloading software applications for your ASRock computer. You can quickly and easily install various apps and support utilities. With ASRock Live Update & APP Shop, you can optimize your system and keep your motherboard up to date simply with a few clicks.

Double-click  on your desktop to access ASRock Live Update & APP Shop utility.

**You need to be connected to the Internet to download apps from the ASRock Live Update & APP Shop.*

3.3.1 UI Overview



Category Panel: The category panel contains several category tabs or buttons that when selected the information panel below displays the relative information.

Information Panel: The information panel in the center displays data about the currently selected category and allows users to perform job-related tasks.

Hot News: The hot news section displays the various latest news. Click on the image to visit the website of the selected news and know more.

3.3.2 Apps

When the "Apps" tab is selected, you will see all the available apps on screen for you to download.

Installing an App

Step 1

Find the app you want to install.



The most recommended app appears on the left side of the screen. The other various apps are shown on the right. Please scroll up and down to see more apps listed.

You can check the price of the app and whether you have already installed it or not.

Free - The red icon displays the price or "Free" if the app is free of charge.

Installed - The green "Installed" icon means the app is installed on your computer.

Step 2

Click on the app icon to see more details about the selected app.

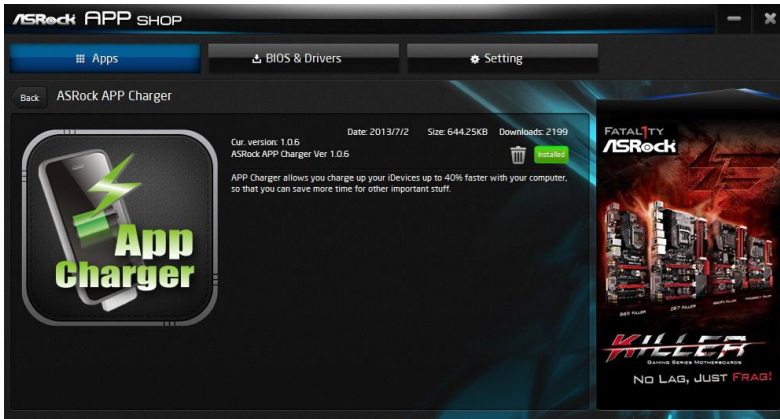
Step 3

If you want to install the app, click on the red icon  to start downloading.



Step 4

When installation completes, you can find the green "Installed" icon appears on the upper right corner.



To uninstall it, simply click on the trash can icon  .
*The trash icon may not appear for certain apps.

Upgrading an App

You can only upgrade the apps you have already installed. When there is an available new version for your app, you will find the mark of "New Version"  appears below the installed app icon.



Step 1

Click on the app icon to see more details.

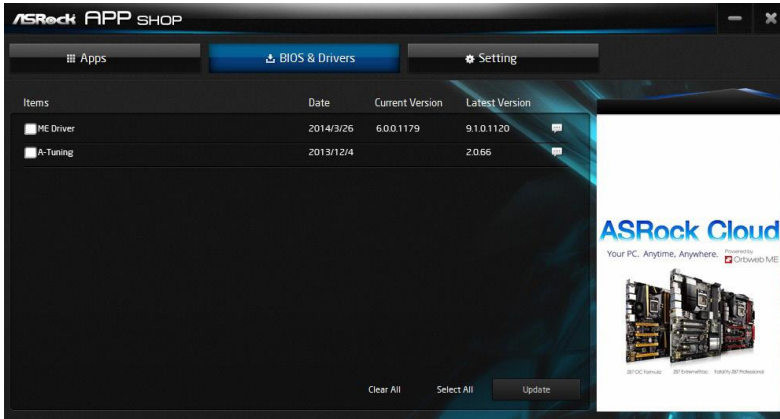
Step 2

Click on the yellow icon  to start upgrading.

3.3.3 BIOS & Drivers

Installing BIOS or Drivers

When the "BIOS & Drivers" tab is selected, you will see a list of recommended or critical updates for the BIOS or drivers. Please update them all soon.



Step 1

Please check the item information before update. Click on ⓘ to see more details.

Step 2

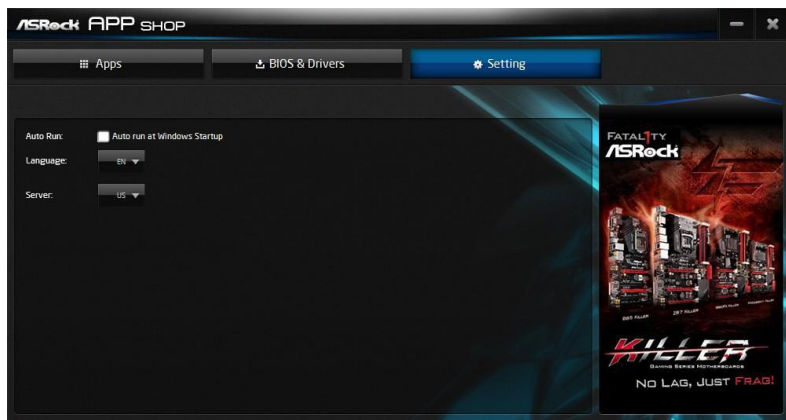
Click to select one or more items you want to update.

Step 3

Click Update to start the update process.

3.3.4 Setting

In the "Setting" page, you can change the language, select the server location, and determine if you want to automatically run the ASRock Live Update & APP Shop on Windows startup.



Chapter 4 UEFI SETUP UTILITY

4.1 Introduction

This section explains how to use the UEFI SETUP UTILITY to configure your system. You may run the UEFI SETUP UTILITY by pressing <F2> or right after you power on the computer, otherwise, the Power-On-Self-Test (POST) will continue with its test routines. If you wish to enter the UEFI SETUP UTILITY after POST, restart the system by pressing <Ctl> + <Alt> + <Delete>, or by pressing the reset button on the system chassis. You may also restart by turning the system off and then back on.



Because the UEFI software is constantly being updated, the following UEFI setup screens and descriptions are for reference purpose only, and they may not exactly match what you see on your screen.

4.2 EZ Mode

The EZ Mode screen appears when you enter the BIOS setup program by default. EZ mode is a dashboard which contains multiple readings of the system's current status. You can check the most crucial information of your system, such as CPU speed, DRAM frequency, SATA information, fan speed, etc.

Press <F6> or click the "Advanced Mode" button at the upper right corner of the screen to switch to "Advanced Mode" for more options.



No.	Function
1	Help
2	Load UEFI Defaults
3	Save Changes and Exit
4	Discard Changes
5	Change Language
6	Switch to Advanced Mode

4.3 Advanced Mode

The Advanced Mode provides more options to configure the BIOS settings. Refer to the following sections for the detailed configurations.

To access the EZ Mode, press <F6> or click the "EZ Mode" button at the upper right corner of the screen.

4.3.1 UEFI Menu Bar

The top of the screen has a menu bar with the following selections:

Main	For setting system time/date information
OC Tweaker	For overclocking configurations
Advanced	For advanced system configurations
Tool	Useful tools
H/W Monitor	Displays current hardware status
Security	For security settings
Boot	For configuring boot settings and boot priority
Exit	Exit the current screen or the UEFI Setup Utility

4.3.2 Navigation Keys

Use <←> key or <→> key to choose among the selections on the menu bar, and use <↑> key or <↓> key to move the cursor up or down to select items, then press <Enter> to get into the sub screen. You can also use the mouse to click your required item.

Please check the following table for the descriptions of each navigation key.

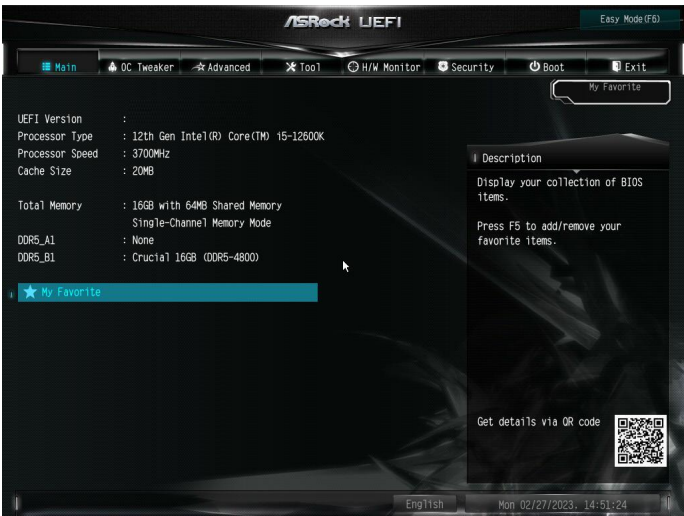
Navigation Key(s)	Description
+ / -	To change option for the selected items
<Tab>	Switch to next function
<PGUP>	Go to the previous page
<PGDN>	Go to the next page
<HOME>	Go to the top of the screen
<END>	Go to the bottom of the screen
<F1>	To display the General Help Screen
<F5>	Add / Remove Favorite
<F7>	Discard changes and exit the SETUP UTILITY
<F9>	Load optimal default values for all the settings
<F10>	Save changes and exit the SETUP UTILITY
<F12>	Print screen
<ESC>	Jump to the Exit Screen or exit the current screen

4.4 Main Screen

When you enter the UEFI SETUP UTILITY, the Main screen will appear and display the system overview.



The availability and location of BIOS settings can be different for different models and BIOS versions.



My Favorite

Display your collection of BIOS items. Press F5 to add/remove your favorite items.

4.5 OC Tweaker Screen

In the OC Tweaker screen, you can set up overclocking features.



Because the UEFI software is constantly being updated, the following UEFI setup screens and descriptions are for reference purpose only, and they may not exactly match what you see on your screen.

CPU Vcore Compensation

This option will make cpu to run at higher vcore as default. Please try to adjust this option when your cpu is not stable at default setting. Higher level will provide higher vcore.

Base Frequency Boost

Enjoy the base frequency boost with the hidden power of processors immediately.

CPU Configuration

CPU Turbo Ratio Information

This item allows users to browse the CPU Turbo Ratio information.

CPU Configuration

CPU P-Core Ratio

The CPU speed is determined by the CPU P-Core Ratio multiplied with the BCLK. Increasing the CPU P-Core Ratio will increase the internal CPU clock speed without affecting the clock speed of other components.

AVX2 Ratio Offset

AVX2 Ratio Offset specifies a negative offset from the CPU Ratio for AVX workloads. AVX is a more stressful workload that lower the AVX ratio to ensure maximum possible ratio for SSE workloads.

CPU E-Core Ratio

The E-Core speed is determined by the E-Core Ratio multiplied with the BCLK. Increasing the E-Core Ratio will increase the internal E-Core clock speed without affecting the clock speed of other components.

CPU Cache Ratio

The CPU Internal Bus Speed Ratio. The maximum should be the same as the CPU Ratio.

BCLK Aware Adaptive Voltage

BCLK Aware Adaptive Voltage enable/disable. When enabled, pcode will be aware of the BCLK frequency when calculating the CPU V/F curves. This is ideal for BCLK OC to avoid high voltage overrides.

Boot Performance Mode

Select the performance state that the BIOS will set before OS handoff.

Ring to Core Ratio Offset

Disable Ring to Core Ratio Offset so the ring and core can run at the same frequency.

SA PLL Frequency Override

Configure SA PLL Frequency.

BCLK TSC HW Fixup

BCLK TSC HW Fixup disable during TSC copy from PMA to APIC.

FLL Overclock Mode

Nominal is good for normal core ratio overclocking. Elevated and Extremely Elevated are good for high BCLK OC.

Intel SpeedStep Technology

Intel SpeedStep technology allows processors to switch between multiple frequencies and voltage points for better power saving and heat dissipation.

Intel Turbo Boost Technology

Intel Turbo Boost Technology enables the processor to run above its base operating frequency when the operating system requests the highest performance state.

Intel Speed Shift Technology

Enable/Disable Intel Speed Shift Technology support. Enabling will expose the CPPC v2 interface to allow for hardware controlled P-states.

Intel Turbo Boost Max Technology 3.0

Intel Turbo Boost Technology enables the processor to run above its base operating frequency when the operating system requests the highest performance state.

Intel Thermal Velocity Boost Voltage Optimizations

This service controls thermal based voltage optimizations for processors that implement the Intel Thermal Velocity Boost (TVB) feature.

Dual Tau Boost

Enable Dual Tau Boost feature. This is only applicable for CMLS 35W/65W/125W skus. This item is only supported with processors with Config TDP support.

Long Duration Power Limit

Configure Package Power Limit 1 in watts. When the limit is exceeded, the CPU ratio will be lowered after a period of time. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

Long Duration Maintained

Configure the period of time until the CPU ratio is lowered when the Long Duration Power Limit is exceeded.

Short Duration Power Limit

Configure Package Power Limit 2 in watts. When the limit is exceeded, the CPU ratio will be lowered immediately. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

CPU Core Current Limit

Configure the current limit of the CPU core. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

GT Current Limit

Configure the current limit of the GT slice. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

DRAM Configuration

Memory Information

Allows users to browse the serial presence detect (SPD) and Intel extreme memory profile (XMP) for DDR5 modules.

DRAM Timing Configuration

Load XMP Setting

Load XMP settings to overclock the memory and perform beyond standard specifications.

DRAM Reference Clock

Select Auto for optimized settings.

DRAM Frequency

If [Auto] is selected, the motherboard will detect the memory module(s) inserted and assign the appropriate frequency automatically.

DRAM Gear Mode

High gear is good for high frequency.

Primary Timing

CAS# Latency (tCL)

The time between sending a column address to the memory and the beginning of the data in response.

RAS# to CAS# Delay (tRCD)

The number of clock cycles required between the opening of a row of memory and accessing columns within it.

Row Precharge (tRP)

The number of clock cycles required between the issuing of the precharge command and opening the next row.

RAS# Active Time (tRAS)

The number of clock cycles required between a bank active command and issuing the precharge command.

Command Rate (CR)

The delay between when a memory chip is selected and when the first active command can be issued.

Secondary Timing

Write Recovery Time (tWR)

The amount of delay that must elapse after the completion of a valid write operation, before an active bank can be precharged.

Refresh Cycle Time (tRFC)

The number of clocks from a Refresh command until the first Activate command to the same rank.

RAS to RAS Delay (tRRD_L)

The number of clocks between two rows activated in different banks of the same rank.

RAS to RAS Delay (tRRD_S)

The number of clocks between two rows activated in different banks of the same rank.

Write to Read Delay (tWTR_L)

The number of clocks between the last valid write operation and the next read command to the same internal bank.

Write to Read Delay (tWTR_S)

The number of clocks between the last valid write operation and the next read command to the same internal bank.

Read to Precharge (tRTP)

The number of clocks that are inserted between a read command to a row precharge command to the same rank.

Four Activate Window (tFAW)

The time window in which four activates are allowed the same rank.

CAS Write Latency (tCWL)

Configure CAS Write Latency.

Third Timing

tREFI

Configure refresh cycles at an average periodic interval.

tCKE

Configure the period of time the DDR5 initiates a minimum of one refresh command internally once it enters Self-Refresh mode.

Turn Around Timing

Turn Around Timing Optimization

Auto is enabled in general case.

TAT Training Value

tRDRD_sg

Configure between module read to read delay.

tRDRD_dg

Configure between module read to read delay.

tRDRD_dr

Configure between module read to read delay.

tRDRD_dd

Configure between module read to read delay.

tRDWR_sg

Configure between module read to write delay.

tRDWR_dg

Configure between module read to write delay.

tRDWR_dr

Configure between module read to write delay.

tRDWR_dd

Configure between module read to write delay.

tWRRD_sg

Configure between module write to read delay.

tWRRD_dg

Configure between module write to read delay.

tWRRD_dr

Configure between module write to read delay.

tWRRD_dd

Configure between module write to read delay.

tWRWR_sg

Configure between module write to write delay.

tWRWR_dg

Configure between module write to write delay.

tWRWR_dr

Configure between module write to write delay.

tWRWR_dd

Configure between module write to write delay.

TAT Runtime Value

tRDRD_sg

Configure between module read to read delay.

tRDRD_dg

Configure between module read to read delay.

tRDRD_dr

Configure between module read to read delay.

tRDRD_dd

Configure between module read to read delay.

tRDWR_sg

Configure between module read to write delay.

tRDWR_dg

Configure between module read to write delay.

tRDWR_dr

Configure between module read to write delay.

tRDWR_dd

Configure between module read to write delay.

tWRRD_sg

Configure between module write to read delay.

tWRRD_dg

Configure between module write to read delay.

tWRRD_dr

Configure between module write to read delay.

tWRRD_dd

Configure between module write to read delay.

tWRWR_sg

Configure between module write to write delay.

tWRWR_dg

Configure between module write to write delay.

tWRWR_dr

Configure between module write to write delay.

tWRWR_dd

Configure between module write to write delay.

Round Trip Timing

Round Trip Timing Optimization

Auto is enabled in general case.

Round Trip Level

Configure round trip level.

Initial RTL IO Delay Offset

Configure round trip latency IO delay initial offset.

Initial RTL FIFO Delay Offset

Configure round trip latency FIFO delay initial offset.

Initial RTL (MC0 C0 A1)

Configure round trip latency initial value.

Initial RTL (MC0 C1 A1)

Configure round trip latency initial value.

Initial RTL (MC1 C0 B1)

Configure round trip latency initial value.

Initial RTL (MC1 C1 B1)

Configure round trip latency initial value.

RTL (MC0 C0 A1)

Configure round trip latency value.

RTL (MC0 C1 A1)

Configure round trip latency value.

RTL (MC1 C0 B1)

Configure round trip latency value.

RTL (MC1 C1 B1)

Configure round trip latency value.

ODT Setting

Dimm ODT Training

ODT values will be optimized by Dimm On-Die Termination Training.

ODT WR (A1)

Configure the memory on die termination resistors' WR for channel A1.

ODT WR (B1)

Configure the memory on die termination resistors' WR for channel B1.

ODT NOM (A1)

Use this to change ODT (CH A1) Auto/Manual settings. The default is [Auto].

ODT NOM (B1)

Use this to change ODT (CH B1) Auto/Manual settings. The default is [Auto].

ODT PARK (A1)

Configure the memory on die termination resistors' PARK for channel A1.

ODT PARK (B1)

Configure the memory on die termination resistors' PARK for channel B1

ODT PARK DQS (A1)

Configure the memory on die termination resistors' PARK DQS for channel A1.

ODT PARK DQS (B1)

Configure the memory on die termination resistors' PARK DQS for channel B1.

ODT CA (A1 Group A)

Configure the memory on die termination resistors' CA for channel A1 Group A.

ODT CA (B1 Group A)

Configure the memory on die termination resistors' CA for channel B1 Group A.

ODT CA (A1 Group B)

Configure the memory on die termination resistors' CA for channel A1 Group B.

ODT CA (B1 Group B)

Configure the memory on die termination resistors' CA for channel B1 Group B.

ODT CS (A1 Group A)

Configure the memory on die termination resistors' CS for channel A1 Group A.

ODT CS (B1 Group A)

Configure the memory on die termination resistors' CS for channel B1 Group A.

ODT CS (A1 Group B)

Configure the memory on die termination resistors' CS for channel A1 Group B.

ODT CS (B1 Group B)

Configure the memory on die termination resistors' CS for channel B1 Group B.

ODT CK (A1 Group A)

Configure the memory on die termination resistors' CK for channel A1 Group A.

ODT CK (B1 Group A)

Configure the memory on die termination resistors' CK for channel B1 Group A.

ODT CK (A1 Group B)

Configure the memory on die termination resistors' CK for channel A1 Group B.

ODT CK (B1 Group B)

Configure the memory on die termination resistors' CK for channel B1 Group B.

Advanced Setting

ASRock Timing Optimization

Configure the fast path through the MRC.

ASRock Second Timing Optimization

Configure the second fast path through the MRC.

MRC Training Respond Time

Try Slowest MRC Training.

Realtime Memory Timing

Configure the realtime memory timings.

[Enabled] The system will allow performing realtime memory timing changes after MRC_DONE.

Reset for MRC Failed

Reset system after MRC training is failed.

MRC Training on Warm Boot

When enabled, memory training will be executed when warm boot.

MRC Fast Boot

Enable Memory Fast Boot to skip DRAM memory training for booting faster.

Voltage Configuration

Voltage Mode

[OC]: Larger range voltage for overclocking.

[STABLE]: Smaller range voltage for stable system.

CPU Core/Cache Voltage

Input voltage for the processor by the external voltage regulator.

CPU Core/Cache Load-Line Calibration

CPU Core/Cache Load-Line Calibration helps prevent CPU Core/Cache voltage droop when the system is under heavy loading.

CPU GT Voltage

Configure the voltage for the integrated GPU.

CPU GT Load-Line Calibration

GT Load-Line Calibration helps prevent integrated GPU voltage droop when the system is under heavy load.

VDD_CPU Voltage

Configure the VDD_CPU voltage.

VCCIN AUX Voltage

Configure the voltage for the VCCIN AUX.

+1.05V PROC Voltage

Configure the CPU voltage (1.05V).

+0.82V PCH Voltage

Configure the chipset voltage (0.82V).

+1.05V PCH Voltage

Configure the chipset voltage (1.05V).

DDR5 PMIC Configuration

VDD Voltage

Configure the memory VDD Voltage.

VDD Voltage Range

Configure the memory VDD Voltage Range.

VDDQ Voltage

Configure the memory VDDQ Voltage.

VDDQ Voltage Range

Configure the memory VDDQ Voltage Range.

VPP Voltage

Configure the memory VPP Voltage.

VDD Eventual Voltage

Configure the memory VDD Eventual Voltage.

VDDQ Eventual Voltage

Configure the memory VDDQ Eventual Voltage.

VPP Eventual Voltage

Configure the memory VPP Eventual Voltage.

AVX Configuration

AVX2 Voltage Guardband Scale Factor

AVX2 Voltage Guardband Scale Factor controls the voltage guardband applied to AVX2 workloads. A value > 1.00 will increase the voltage guardband, and < 1.00 will decrease the voltage guardband.

FIVR Configuration

P-Core Voltage Mode

Selects between Adaptive and Override Voltage modes. In Override Mode, the voltage selected will be applied over all operating frequencies. In Adaptive mode, the voltage is interpolated only in turbo mode.

Extra Turbo Voltage

Specifies the extra turbo voltage applied while the IA Core is operating in turbo mode.

VF Offset Mode

Selects between Legacy and Selection modes. Need Reset System after enabling OverClocking Feature to initialize the default value. In Legacy Mode, setting a

global offset for the entire VF curve. In Selection modes, setting a selected VF point.

VF Configuration Scope

Allows all cores VF curve or per-core VF curve configuration.

Core Voltage Offset

Specifies the offset voltage applied to the IA Core domain. This voltage is specified in millivolts.

Offset Prefix

Sets the offset value as positive or negative.

E-Core L2 Voltage Mode

Selects between adaptive and Override Voltage modes. In Override Mode the voltage selected will be applied over all operating frequencies. In Adaptive Mode the voltage is interpolated only in turbo mode. Uses Mailbox 0SR 0x150, cmd 0x10, 0x11.

Extra Turbo Voltage

Specifies the extra turbo voltage applied while Atom L2 is operating in turbo mode. Uses Mailbox MSR 0x150, cmd 0x10, 0x11. Range 0-2000 mV.

E-Core L2 Voltage Offset

Specifies the Offset Voltage applied to the Atom L2 domain. This voltage is specified in millivolts. Uses Mailbox MSR 0x150, cmd 0x11. Range -500 to 500 mV.

Offset Prefix

Sets the offset value as positive or negative.

Ring Voltage Mode

Selects between adaptive and Override Voltage modes. In Override Mode the voltage selected will be applied over all operating frequencies. In Adaptive Mode the voltage is interpolated only in turbo mode. Uses Mailbox 0SR 0x150, cmd 0x10, 0x11.

Extra Turbo Voltage

Specifies the extra turbo voltage applied while ring is operating in turbo mode. Uses Mailbox MSR 0x150, cmd 0x10, 0x11. Range 0-2000 mV.

VF Offset Mode

Selects between Legacy and Selection modes. Need Reset System after enabling OverClocking Feature to initialize the default value. In Legacy Mode, setting a

global offset for the entire VF curve. In Selection modes, setting a selected VF point.

Ring Voltage Offset

Specifies the Offset Voltage applied to the Ring domain. This voltage is specified in millivolts. Uses Mailbox MSR 0x150, cmd 0x11. Range -500 to 500 mV.

Offset Prefix

Sets the offset value as positive or negative.

GT Voltage Mode

Selects between adaptive and Override Voltage modes. In Override Mode the voltage selected will be applied over all operating frequencies. In Adaptive Mode the voltage is interpolated only in turbo mode. Uses Mailbox 0SR 0x150, cmd 0x10, 0x11.

Extra Turbo Voltage

Specifies the extra turbo voltage applied while GT is operating in turbo mode. Uses Mailbox MSR 0x150, cmd 0x10, 0x11. Range 0-2000 mV.

GT Voltage Offset

Specifies the Offset Voltage applied to the GT domain. This voltage is specified in millivolts. Uses Mailbox MSR 0x150, cmd 0x11. Range -500 to 500 mV.

Offset Prefix

Sets the offset value as positive or negative.

System Agent Voltage Mode

Selects between adaptive and Override Voltage modes. In Override Mode the voltage selected will be applied over all operating frequencies. In Adaptive Mode the voltage is interpolated only in turbo mode.

Extra Turbo Voltage

Specifies the extra turbo voltage applied while SA Uncore is operating in turbo mode. Uses Mailbox MSR 0x150, cmd 0x10, 0x11. Range 0-2000 mV.

System Agent Voltage Offset

Specifies the Offset Voltage applied to the Uncore domain. This voltage is specified in millivolts.

Offset Prefix

Sets the offset value as positive or negative.

4.6 Advanced Screen

In this section, you may set the configurations for the following items: CPU Configuration, Chipset Configuration, Storage Configuration, Super IO Configuration, ACPI Configuration, USB Configuration and Trusted Computing.



Setting wrong values in this section may cause the system to malfunction.

UEFI Configuration

UEFI Setup Style

Select the default mode when entering the UEFI setup utility.

Active Page on Entry

Select the default page when entering the UEFI setup utility.

Full HD UEFI

When [Auto] is selected, the resolution will be set to 1920 x 1080 if the monitor supports Full HD resolution. If the monitor does not support Full HD resolution, then the resolution will be set to 1024 x 768. When [Disable] is selected, the resolution will be set to 1024 x 768 directly.

4.6.1 CPU Configuration



Processor E-Core Information

This item displays the E-Core Information.

Processor P-Core Information

This item displays the P-Core Information.

Intel Hyper Threading Technology

Intel Hyper Threading Technology allows multiple threads to run on each core, so that the overall performance on threaded software is improved.

Active Processor P-Cores

Select the number of cores to enable in each processor package.

Active Processor E-Cores

Select the number of E-Cores to enable in each processor package.

CPU C States Support

Enable CPU C States Support for power saving. It is recommended to keep C6 and C7 enabled for better power saving.

Enhanced Halt State (C1E)

Enable Enhanced Halt State (C1E) for lower power consumption.

CPU C6 State Support

Enable C6 deep sleep state for lower power consumption.

CPU C7 State Support

Enable C7 deep sleep state for lower power consumption.

Package C State Support

Enable CPU, PCIe, Memory, Graphics C State Support for power saving.

CFG Lock

This item allows you to disable or enable the CFG Lock.

C6DRAM

Enable/Disable moving of DRAM contents to PRM memory when CPU is in C6 state.

CPU Thermal Throttling

Enable CPU internal thermal control mechanisms to keep the CPU from overheating.

Intel AVX/AVX2

Enable/Disable the Intel AVX and AVX2 Instructions. This is applicable for Big Core only.

Intel AVX-512

Enable/Disable the Intel AVX-512 (a.k.a. AVX3) Instructions. This is applicable for Big Core only.

Intel Virtualization Technology

Intel Virtualization Technology allows a platform to run multiple operating systems and applications in independent partitions, so that one computer system can function as multiple virtual systems.

Hardware Prefetcher

Automatically prefetch data and code for the processor. Enable for better performance.

Adjacent Cache Line Prefetch

Automatically prefetch the subsequent cache line while retrieving the currently requested cache line. Enable for better performance.

Legacy Game Compatibility Mode

When enabled, pressing the scroll lock key will toggle the Efficient cores between being parked when Scroll Lock LED is on and un-parked when LED is off.

4.6.2 Chipset Configuration



Primary Graphics Adapter

Select a primary VGA.

Above 4G Decoding

Enable or disable 64bit capable Devices to be decoded in Above 4G Address Space (only if the system supports 64 bit PCI decoding).

C.A.M (Clever Access Memory)

If system has Resizable BAR capable PCIe Devices, use this option to enable or disable Resizable BAR support (only of the system supports 64-bit PCI decoding).

VT-d

Intel® Virtualization Technology for Directed I/O helps your virtual machine monitor better utilize hardware by improving application compatibility and reliability, and providing additional levels of manageability, security, isolation, and I/O performance.

SR-IOV Support

If system has SR-IOV capable PCIe Devices, this option Enables or Disables Single Root IO Virtualization Support.

DMI Link Speed

Configure DMI Slot Link Speed. Auto mode is optimizing for overclocking.

PCIE1 Link Speed

Select the link speed for PCIE1.

PCIE2 Link Speed

Select the link speed for PCIE2.

PCIE3 Link Speed

Select the link speed for PCIE3.

PCI Express Native Control

Select Enable for enhanced PCI Express power saving in OS.

PCIE ASPM Support

This option enables/disables the ASPM support for all CPU downstream devices.

PCH PCIE ASPM Support

This option enables/disables the ASPM support for all PCH PCIE devices.

DMI ASPM Support

This option enables/disables the control of ASPM on CPU side of the DMI Link.

PCH DMI ASPM Support

This option enables/disables the ASPM support for all PCH DMI devices.

Share Memory

Configure the size of memory that is allocated to the integrated graphics processor when the system boots up.

IGPU Multi-Monitor

Select disable to disable the integrated graphics when an external graphics card is installed. Select enable to keep the integrated graphics enabled at all times.

Realtek RTL8111H

Enable or disable the onboard network interface controller.

Onboard HD Audio

Enable/disable onboard HD audio. Set to Auto to enable onboard HD audio and automatically disable it when a sound card is installed.

Front Panel

Enable/disable front panel HD audio.

Onboard HDMI HD Audio

Enable audio for the onboard digital outputs.

Onboard WAN Device

Use this item to enable or disable the onboard WAN device.

Deep Sleep

Configure deep sleep mode for power saving when the computer is shut down.

Restore on AC/Power Loss

Select the power state after a power failure. If [Power Off] is selected, the power will remain off when the power recovers. If [Power On] is selected, the system will start to boot up when the power recovers.

4.6.3 Storage Configuration



SATA Controller(s)

Enable/disable the SATA controllers.

SATA Mode Selection

AHCI: Supports new features that improve performance.

Hybrid Storage Detection and Configuration Mode

This item allows you select Hybrid Storage Detection and Configuration Mode.

SATA Aggressive Link Power Management

SATA Aggressive Link Power Management allows SATA devices to enter a low power state during periods of inactivity to save power. It is only supported by AHCI mode.

Hard Disk S.M.A.R.T.

S.M.A.R.T stands for Self-Monitoring, Analysis, and Reporting Technology. It is a monitoring system for computer hard disk drives to detect and report on various indicators of reliability.

VMD Configuration (for B660M-HDVP/D5 R2.0 only)

This item allows you to enable or disable the Intel VMD support function.

4.6.4 Super IO Configuration



Serial Port 1

Enable or disable the Serial port 1.

Serial Port Address

Select the address of the Serial port.

Serial Port 2

Enable or disable the Serial port 2.

Serial Port Address

Select the address of the Serial port.

Serial Port/UART Switch

Select Serial Port or UART for Port 80 debug

Parallel Port

Enable or disable the Parallel port.

Change Settings

Select the address of the Parallel port.

Device Mode

Select the device mode according to your connected device.

4.6.5 ACPI Configuration



Suspend to RAM

Select disable for ACPI suspend type S1. It is recommended to select auto for ACPI S3 power saving.

PS/2 Keyboard S4/S5 Wakeup Support

Allow the system to be waked up by a PS/2 Keyboard in S4/S5.

PCIe Devices Power On

Allow the system to be waked up by a PCIe device and enable wake on LAN.

RTC Alarm Power On

Allow the system to be waked up by the real time clock alarm. Set it to By OS to let it be handled by your operating system.

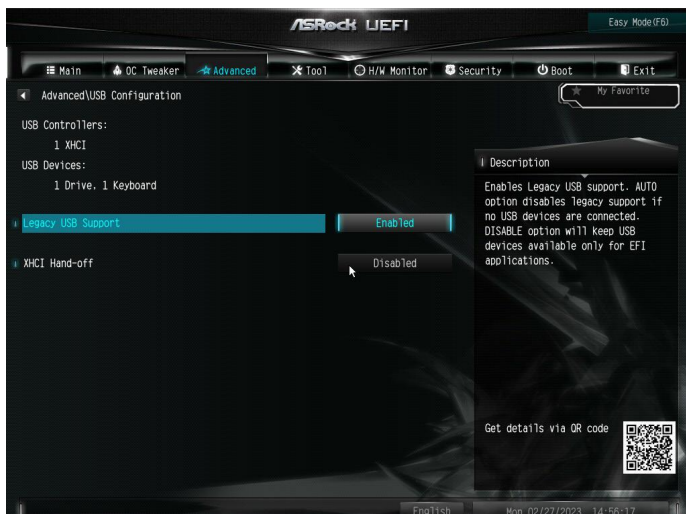
USB Keyboard/Remote Power On

Allow the system to be waked up by an USB keyboard or remote controller.

USB Mouse Power On

Allow the system to be waked up by an USB mouse.

4.6.6 USB Configuration



Legacy USB Support

Enable or disable Legacy OS Support for USB 2.0 devices. If you encounter USB compatibility issues it is recommended to disable legacy USB support. Select UEFI Setup Only to support USB devices under the UEFI setup and Windows/Linux operating systems only.

XHCI Hand-off

This is a workaround for OSes without XHCI hand-off support. The XHCI ownership change should be claimed by XHCI driver.

4.6.7 Trusted Computing



NOTE: Options vary depending on the version of your connected TPM module.

Security Device Support

Use this item to enable or disable BIOS support for security device. O.S. will not show Security Device. TCG EFI protocol and INT1A interface will not be available.

Active PCR banks

This item displays active PCR Banks.

Available PCR Banks

This item displays available PCR Banks.

SHA256 PCR Bank

Use this item to enable or disable SHA256 PCR Bank.

SHA384 PCR Bank

Use this item to enable or disable SHA384 PCR Bank.

SM3_256 PCR Bank

Use this item to enable or disable SM3_256 PCR Bank.

Pending Operation

Schedule an Operation for the Security Device.

NOTE: Your computer will reboot during restart in order to change State of the Device.

Platform Hierarchy

Use this item to enable or disable Platform Hierarchy.

Storage Hierarchy

Use this item to enable or disable Storage Hierarchy.

Endorsement Hierarchy

Use this item to enable or disable Endorsement Hierarchy.

Physical Presence Spec version

Select this item to tell OS to support PPI spec version 1.2 or 1.3. Please note that some HCK tests might not support version 1.3.

TPM 2.0 InterfaceType (CRB)

Select the Communication Interface to TPM 2.0 Device

Device Select

Use this item to select the TPM device to be supported. TPM 1.2 will restrict support to TPM 1.2 devices. TPM 2.0 will restrict support to TPM 2.0 devices. Auto will support both with the default set to TPM 2.0 devices. If TPM 2.0 devices are not found, TPM 1.2 devices will be enumerated.

4.7 Tools



UEFI Tech Service

Contact ASRock Tech Service if you are having trouble with your PC. Please setup network configuration before using UEFI Tech Service.

Easy RAID Installer (for B660M-HDVP/D5 R2.0 only)

Easy RAID Installer helps you to copy the RAID driver from the support CD to your USB storage device. After copying the drivers please change the SATA mode to RAID, then you can start installing the operating system in RAID mode.

SSD Secure Erase Tool

All the SSD's listed that supports Secure Erase function.

NVME Sanitization Tool

After you Sanitize SSD, all user data will be permanently destroyed on the SSD and cannot be recovered.

Instant Flash

Save UEFI files in your USB storage device and run Instant Flash to update your UEFI.

Internet Flash - DHCP (Auto IP), Auto

ASRock Internet Flash downloads and updates the latest UEFI firmware version from our servers for you. Please setup network configuration before using Internet Flash.

*For BIOS backup and recovery purpose, it is recommended to plug in your USB pen drive before using this function.

Network Configuration

Use this to configure internet connection settings for Internet Flash.



Internet Setting

Enable or disable sound effects in the setup utility.

UEFI Download Server

Select a server to download the UEFI firmware.

4.8 Hardware Health Event Monitoring Screen

This section allows you to monitor the status of the hardware on your system, including the parameters of the CPU temperature, motherboard temperature, fan speed and voltage.



Fan Tuning

Measure Fan Min Duty Cycle.

Fan-Tastic Tuning

Select a fan mode for CPU Fan, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

CPU Fan 1 Setting

Select a fan mode for CPU Fan 1, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

CPU Fan 1 Step Up

Set the value of CPU Fan 1 Step Up.

CPU Fan 1 Step Down

Set the value of CPU Fan 1 Step Down.

CHA_FAN1 / W_PUMP Switch

Select Chassis Fan 1 or Water Pump mode.

Chassis Fan 1 Control Mode

Select PWM mode or DC mode for Chassis Fan 1.

Chassis Fan 1 Setting

Select a fan mode for Chassis Fan 1, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

Chassis Fan 1 Temp Source

Select a fan temperature source for Chassis Fan 1.

Chassis Fan 1 Step Up

Set the value of Chassis Fan 1 Step Up.

Chassis Fan 1 Step Down

Set the value of Chassis Fan 1 Step Down.

Chassis Fan 2 Setting

Select a fan mode for Chassis Fan 2, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

Chassis Fan 2 Temp Source

Select a fan temperature source for Chassis Fan 2.

Chassis Fan 2 Step Up

Set the value of Chassis Fan 2 Step Up.

Chassis Fan 2 Step Down

Set the value of Chassis Fan 2 Step Down.

Case Open Feature

Enable or disable Case Open Feature to detect whether the chassis cover has been removed.

4.9 Security Screen

In this section you may set or change the supervisor/user password for the system. You may also clear the user password.



Supervisor Password

Set or change the password for the administrator account. Only the administrator has authority to change the settings in the UEFI Setup Utility. Leave it blank and press enter to remove the password.

User Password

Set or change the password for the user account. Users are unable to change the settings in the UEFI Setup Utility. Leave it blank and press enter to remove the password.

Secure Boot

Use this item to enable or disable support for Secure Boot.

Intel(R) Platform Trust Technology

Enable/disable Intel PTT in ME. Disable this option to use discrete TPM Module.

4.10 Boot Screen

This section displays the available devices on your system for you to configure the boot settings and the boot priority.



Fast Boot

Fast Boot minimizes your computer's boot time. In fast mode you may not boot from an USB storage device. The VBIOS must support UEFI GOP if you are using an external graphics card. Please notice that Ultra Fast mode will boot so fast that the only way to enter this UEFI Setup Utility is to Clear CMOS or run the Restart to UEFI utility in Windows.

Boot From Onboard LAN

Allow the system to be waked up by the onboard LAN.

Setup Prompt Timeout

Configure the number of seconds to wait for the setup hot key.

Bootup Num-Lock

Select whether Num Lock should be turned on or off when the system boots up.

Boot Beep

Select whether the Boot Beep should be turned on or off when the system boots up. Please note that a buzzer is needed.

Full Screen Logo

Enable to display the boot logo or disable to show normal POST messages.

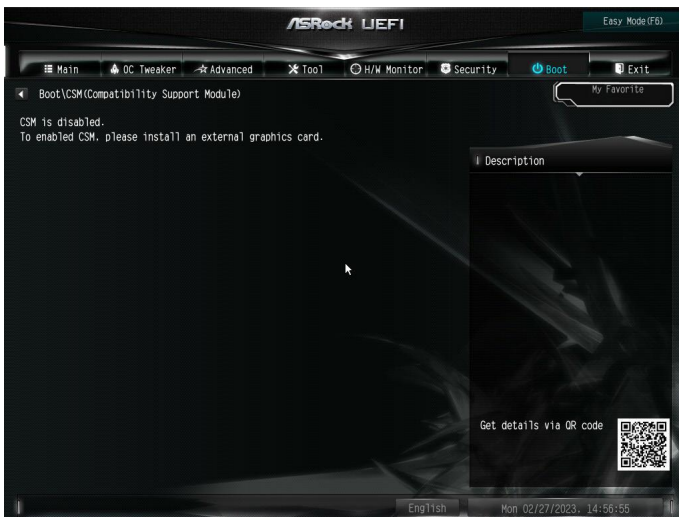
AddOn ROM Display

Enable AddOn ROM Display to see the AddOn ROM messages or configure the AddOn ROM if you've enabled Full Screen Logo. Disable for faster boot speed.

Boot Failure Guard Message

If the computer fails to boot for a number of times the system automatically restores the default settings.

CSM (Compatibility Support Module)



CSM

Enable to launch the Compatibility Support Module. Please do not disable unless you're running a WHCK test.

Launch PXE OpROM Policy

Select UEFI only to run those that support UEFI option ROM only. Select Legacy only to run those that support legacy option ROM only. Select Do not launch to not execute both legacy and UEFI option ROM.

Launch Storage OpROM Policy

Select UEFI only to run those that support UEFI option ROM only. Select Legacy only to run those that support legacy option ROM only. Select Do not launch to not execute both legacy and UEFI option ROM.

Other PCI Device ROM Priority

For PCI devices other than Network, Mass storage or Video defines which OpROM to launch.

4.11 Exit Screen



Save Changes and Exit

When you select this option the following message, “Save configuration changes and exit setup?” will pop out. Select [OK] to save changes and exit the UEFI SETUP UTILITY.

Discard Changes and Exit

When you select this option the following message, “Discard changes and exit setup?” will pop out. Select [OK] to exit the UEFI SETUP UTILITY without saving any changes.

Discard Changes

When you select this option the following message, “Discard changes?” will pop out. Select [OK] to discard all changes.

Load UEFI Defaults

Load UEFI default values for all options. The F9 key can be used for this operation.

Launch EFI Shell from filesystem device

Copy shellx64.efi to the root directory to launch EFI Shell.

Contact Information

If you need to contact ASRock or want to know more about ASRock, you're welcome to visit ASRock's website at <http://www.asrock.com>; or you may contact your dealer for further information. For technical questions, please submit a support request form at <https://event.asrock.com/tsd.asp>

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DECLARATION OF CONFORMITY

Per FCC Part 2 Section 2.1077(a)



Responsible Party Name: ASRock Incorporation

Address: 13848 Magnolia Ave, Chino, CA91710

Phone/Fax No: +1-909-590-8308/+1-909-590-1026

hereby declares that the product

Product Name : Motherboard

Model Number : B660M-HDVP/D5 R2.0 / H610M-HDVP/D5 R2.0

Conforms to the following specifications:

☒ FCC Part 15, Subpart B, Unintentional Radiators

Supplementary Information:

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Representative Person's Name: Jason

Signature: 

Date : May 12, 2017

EU Declaration of Conformity



For the following equipment:

Motherboard

(Product Name)

B660M-HDVP/D5 R2.0 / H610M-HDVP/D5 R2.0 / ASRock

(Model Designation / Trade Name)

ASRock Incorporation

(Manufacturer Name)

2F, No.37, Sec. 2, Jhongyang S. Rd., Beitou District, Taipei City 112, Taiwan (R.O.C.)

(Manufacturer Address)

EMC Directive – 2014/30/EU

EN 55032: 2015 / A11: 2020, EN 55035: 2017 / A11: 2020

EN IEC 61000-3-2: 2019, EN 61000-3-3: 2013

RoHS Directive - 2011/65/EU

2015/863/EU, EN IEC 63000:2018



(EU conformity marking)

ASRock EUROPE B.V.

(Company Name)

Bijsterhuizen 1111 6546 AR Nijmegen The Netherlands

(Company Address)

Person responsible for making this declaration:

(Name, Surname)

A.V.P

(Position / Title)

April 11, 2022

(Date)



EU Declaration of Conformity



Product:

Product Motherboard
Model / Brand / SN. B660M-HDVP/D5 R2.0 / H610M-HDVP/D5 R2.0 / ASRock

Authorized Representative (UK-GB):

Name: Gary Tsui
Address: Bijsterhuizen 11-11, 6546 AR Nijmegen, The Netherlands
Contact person: Gary Tsui

This declaration is issued under the sole responsibility of the mentioned Manufacturer. The subject equipment under declaration is in conformity with the UK-GB Regulation(s) below:

The Electromagnetic Compatibility Regulations 2016 (S.I. 2016/1091)

EN 55032: 2015 / A11: 2020, EN 55035: 2017 / A11: 2020, EN IEC 61000-3-2: 2019, EN 61000-3-3: 2013

The Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment Regulations 2012

2015/863/EU, EN IEC 63000:2018

The following manufacturer outside the UK-GB is responsible for this declaration:

ASRock Incorporation

(Company Name)

2F, No.37, Sec. 2, Jhongyang S. Rd., Beitou District, Taipei City 112, Taiwan (R.O.C.)

(Company Address)

Person responsible for making this declaration:

Jason Chou

(Name, Surname)

A.V.P

(Position / Title)

Taipei

(Place)

April 11, 2022

(Date)

(Legal Signature)